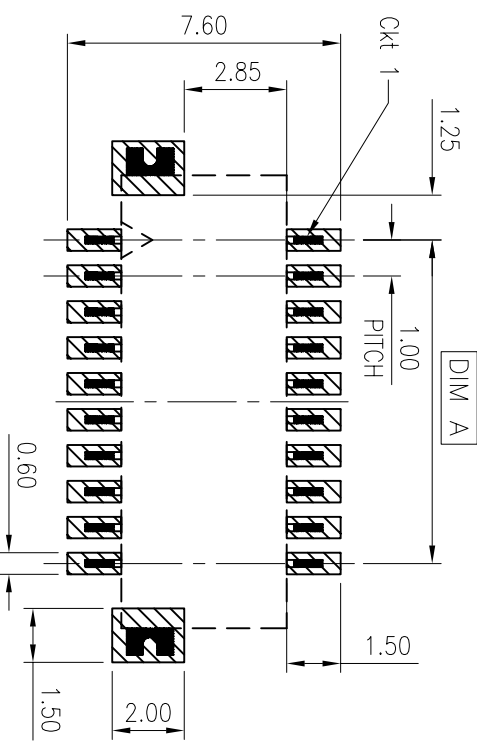
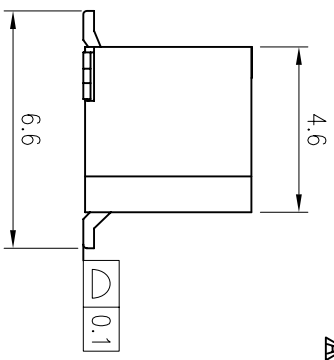
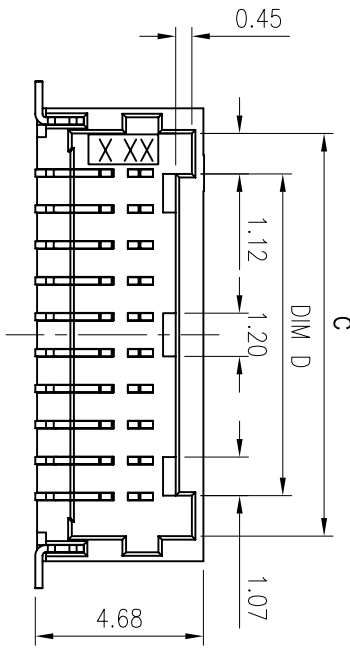
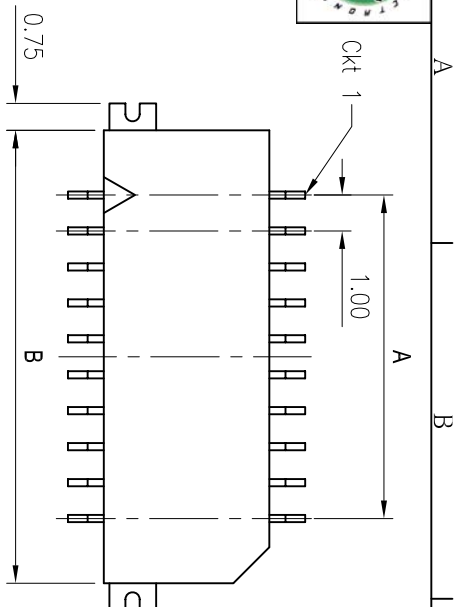


- NOTES:
- MATERIAL:
 - 1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP., UL94V-0.
 - 1.2 CONTACT: COPPER ALLOY
 - 1.3 FITTING NAIL: COPPER ALLOY
 - FINISH:
 - 2.1 CONTACT: 50u"~100u" NICKEL UNDERPLATING OVERALL.
 - 1:1u"~3u" GOLD FLASH PLATING OVERALL.
 - N:100u"~200u" MATT TIN OVERALL,
 - △ C: 15u" GOLD ON CONTACT FOR LEAD FREE
 - REFLOW SOLDER CAPABLE TO 260° C PER ACES SPEC.
 - SPEC. PLS. REFER TO PS-50251-xxxxx-xxx
 - PACKAGE PLS. REFER TO 87241-XXXX-TRP
 - PART NUMBER

P/N Legend	
50257-XXX X X -XXX	
No. of Ckts	XXX
Packing	001
0: Tape & Reel	Color
1: Tube	BLACK

Plating _____
N: Matt Tin(lead free)
1: G/F over all(lead free)
△C: 15u" GOLD ON CONTACT FOR LEAD FREE

CKTS	DIM A	DIM B	DIM C	DIM D
20	9.0	12.6	11.2	8.95
30	14.0	17.6	16.2	13.95
40	19.0	22.6	21.2	18.95
46	22.0	25.6	24.2	21.95
50	24.0	27.6	26.2	23.95

一般公差		宏致電子股份有限公司	
TOLERANCES	XX ±0.15	Aces Electronic Co.,Ltd.	
ANGLES	±2°		
檢驗尺寸標示	品名 (TITLE)	製圖 (DR)	
SYMBOLS	1.0mm WTB WAFER	08/10/16	
CLASSIFICATION	R/A D/R SMT TYPE	審核 (CHKD)	
圖號 (DWG NO)	50257-XXXX-XXX	核准 (APPD)	
MARK IS CRITICAL DIM.		張數 (SHEET)	
MARK IS MAJOR DIM.		1 OF 1	
表面處理 (FINISH)	比例 (SCALE)	單位 (UNITS)	SIZE
	5:1	mm	A4
			B

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05